

LLSD103A - 103C

SURFACE MOUNT SCHOTTKY BARRIER DIODE

NOT RECOMMENDED FOR NEW DESIGNS PLEASE USE SD103AW - SD103CW

Low Forward Voltage Drop

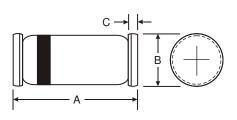
Features

- Guard Ring Construction for Transient Protection
- Fast Reverse Recovery Time
- Lead Free Finish, RoHS Compliant (Note 3)

Mechanical Data

- Case: MiniMELF
- Case Material: Glass. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Sn97.5Ag2.5. Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Ordering Information: See Last Page
- Marking: Cathode Band Only
- Weight: 0.05 grams (approximate)

Maximum Ratings @ $T_A = 25^{\circ}C$ unless otherwise specified



MiniMELF				
Dim	Min	Max		
Α	3.30	3.70		
В	1.30	1.60		
С	0.28	0.50		
All Dimensions in mm				

Characteristic		Symbol	LLSD103A	LLSD103B	LLSD103C	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	40	30	20	V
RMS Reverse Voltage		V _{R(RMS)}	28	21	14	V
Forward Continuous Current (Note 1)		I _{FM}		350		mA
Repetitive Peak Forward Current	@ t≤1.0s	I _{FRM}	1.0			Α
Non-Repetitive Peak Forward Surge Current	@ t ≤ 1.0s @ t = 10ms	I _{FSM}	1.5 7.5			А
Power Dissipation (Note 1)		Pd		400		mW
Thermal Resistance, Junction to Ambient Air (Note 1)		R _{θJA}	250			°C/W
Operating Temperature Range		Tj		-55 to +125		°C
Storage Temperature Range		T _{STG}		-55 to +150		°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

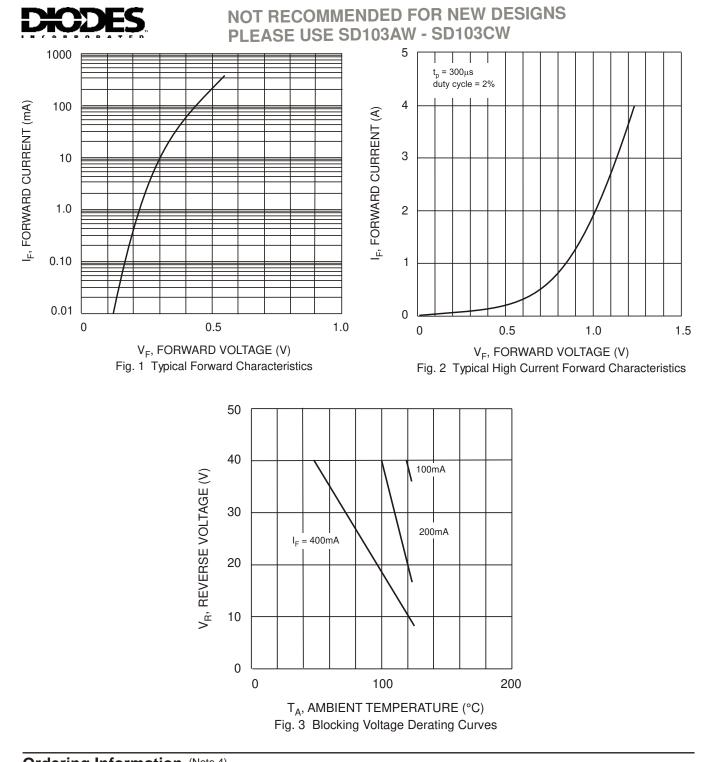
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage		VF		_	0.37 0.60	V	$I_F = 20mA$ $I_F = 200mA$
Peak Reverse Current (Note 2)	LLSD103A LLSD103B LLSD103C	I _R		_	5.0	μΑ	$V_{R} = 30V$ $V_{R} = 20V$ $V_{R} = 10V$
Total Capacitance		CT		50	_	pF	$V_{R} = 0V, f = 1.0MHz$
Reverse Recovery Time		t _{rr}	—		10	ns	$I_{F} = I_{R} = 50 \text{mA to } 200 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100 \Omega$

Note: 1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website

at http://www.diodes.com/datasheets/ap02001.pdf.

2. Short duration test pulse used to minimize self-heating effect.

 EC Directive 2002/95/EC (RoHS) revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied where applicable, see EU Directive Annex Notes 5 and 7.



Ordering Information (Note 4)				
Device	Packaging	Shipping		
LLSD103A-7	MiniMELF	2.5K//Tape & Reel, 7-inch		
LLSD103A-13	MiniMELF	10K/Tape & Reel, 13-inch		
LLSD103B-7	MiniMELF	2.5K/Tape & Reel, 7-inch		
LLSD103B-13	MiniMELF	10K/Tape & Reel, 13-inch		
LLSD103C-7	MiniMELF	2.5K/Tape & Reel, 7-inch		
LLSD103C-13	MiniMELF	10K/Tape & Reel, 13-inch		

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02007.pdf.



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